

To all our customers

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Renesas Technology Corp.  
Customer Support Dept.  
April 1, 2003

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# HD74HC138

## 3-to-8-line Decoder/Demultiplexer



ADE-205-444 (Z)

1st. Edition

Sep. 2000

### Description

The HD74HC138 has 3 binary select inputs (A, B and C). If the device is enabled these inputs determine which one of the eight normally high outputs will go low. Two active low and one active high enables ( $G_1$ ,  $G_{2A}$  and  $G_{2B}$ ) are provided to ease the cascading of decoders.

### Features

- High Speed Operation:  $t_{pd}$  (A, B, C to Y) = 16.5 ns typ ( $C_L = 50$  pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage:  $V_{CC} = 2$  V to 6 V
- Low Input Current: 1  $\mu$ A max
- Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max ( $T_a = 25^\circ\text{C}$ )

### Function Table

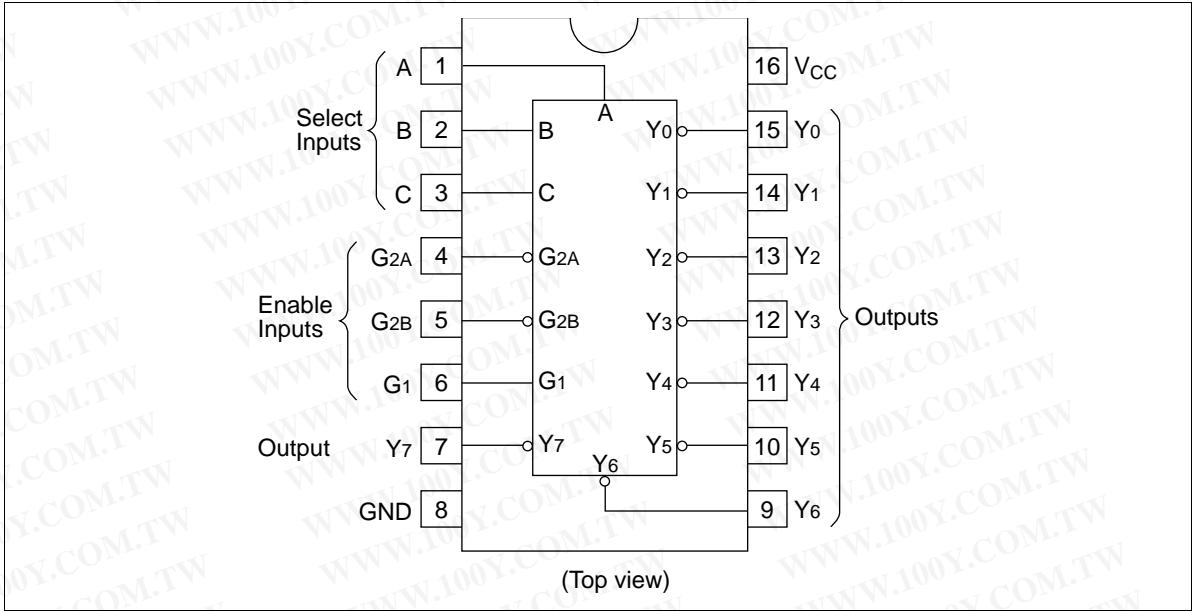
#### Inputs

Enable			Select			Outputs							
$G_1$	$G_{2A}$	$G_{2B}$	C	B	A	$Y_0$	$Y_1$	$Y_2$	$Y_3$	$Y_4$	$Y_5$	$Y_6$	$Y_7$
X	X	H	X	X	X	H	H	H	H	H	H	H	H
X	H	X	X	X	X	H	H	H	H	H	H	H	H
L	X	X	X	X	X	H	H	H	H	H	H	H	H
H	L	L	L	L	L	L	H	H	H	H	H	H	H
H	L	L	L	L	H	H	L	H	H	H	H	H	H
H	L	L	L	H	L	H	H	L	H	H	H	H	H
H	L	L	L	H	H	H	H	H	L	H	H	H	H
H	L	L	H	L	L	H	H	H	H	L	H	H	H
H	L	L	H	L	H	H	H	H	H	H	L	H	H
H	L	L	H	H	L	H	H	H	H	H	H	L	H
H	L	L	H	H	H	H	H	H	H	H	H	H	L

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## Pin Arrangement



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## DC Characteristics

Item	Symbol	V <sub>CC</sub> (V)	Ta = 25°C		Ta = -40 to +85°C		Unit	Test Conditions		
			Min	Typ	Max	Min			Max	
Input voltage	V <sub>IH</sub>	2.0	1.5	—	—	1.5	—	V		
		4.5	3.15	—	—	3.15	—			
		6.0	4.2	—	—	4.2	—			
	V <sub>IL</sub>	2.0	—	—	0.5	—	0.5	V		
		4.5	—	—	1.35	—	1.35			
		6.0	—	—	1.8	—	1.8			
Output voltage	V <sub>OH</sub>	2.0	1.9	2.0	—	1.9	—	V	Vin = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = -20 μA	
		4.5	4.4	4.5	—	4.4	—			
		6.0	5.9	6.0	—	5.9	—			
		4.5	4.18	—	—	4.13	—			I <sub>OH</sub> = -4 mA
		6.0	5.68	—	—	5.63	—			I <sub>OH</sub> = -5.2 mA
		6.0	—	0.0	0.1	—	0.1			V
	4.5	—	0.0	0.1	—	0.1				
	6.0	—	0.0	0.1	—	0.1				
	4.5	—	—	0.26	—	0.33	I <sub>OL</sub> = 4 mA			
	6.0	—	—	0.26	—	0.33	I <sub>OL</sub> = 5.2 mA			
	6.0	—	—	±0.1	—	±1.0	μA	Vin = V <sub>CC</sub> or GND		
	Quiescent supply current	I <sub>CC</sub>	6.0	—	—	4.0	—	40	μA	Vin = V <sub>CC</sub> or GND, I <sub>out</sub> = 0 μA

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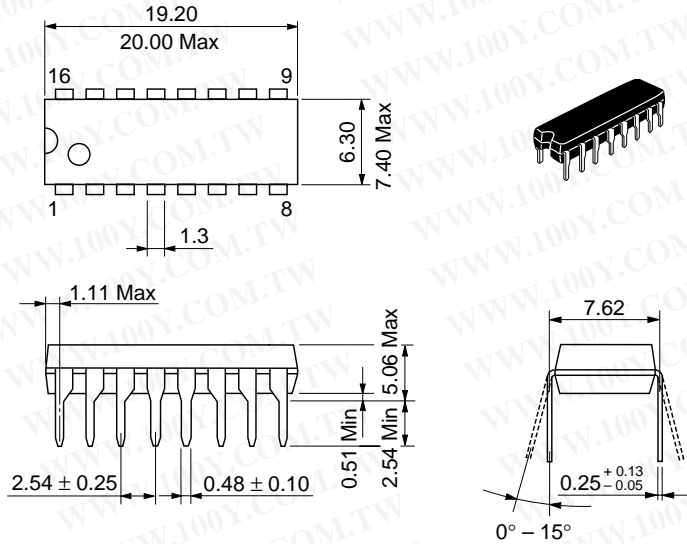
## AC Characteristics ( $C_L = 50$ pF, Input $t_r = t_f = 6$ ns)

Item	Symbol	$V_{CC}$ (V)	$T_a = 25^\circ\text{C}$		$T_a = -40$ to $+85^\circ\text{C}$		Unit	Test Conditions			
			Min	Typ	Max	Min			Max		
Propagation delay time	$t_{PHL}$	2.0	—	—	175	—	220	ns	A, B or C to Output		
		4.5	—	17	35	—	44				
		6.0	—	—	30	—	37				
		2.0	—	—	150	—	190				
		4.5	—	16	30	—	38				
		6.0	—	—	26	—	33				
	$t_{PLH}$	2.0	—	—	150	—	190	ns	$G_1$ to Output		
		4.5	—	16	30	—	38				
		6.0	—	—	26	—	33				
		2.0	—	—	150	—	190				
		4.5	—	17	30	—	38				
		6.0	—	—	26	—	33				
	$t_{PHL}$	$t_{PHL}$	2.0	—	—	175	—	220	ns	$G_{2A}$ or $G_{2B}$ to Output	
			4.5	—	15	35	—	44			
			6.0	—	—	30	—	37			
			2.0	—	—	150	—	190			
			4.5	—	17	30	—	38			
			6.0	—	—	26	—	33			
$t_{PLH}$		2.0	—	—	150	—	190	ns			
		4.5	—	17	30	—	38				
		6.0	—	—	26	—	33				
		2.0	—	—	75	—	95			ns	Output rise/fall time
		4.5	—	5	15	—	19				
		6.0	—	—	13	—	16				
Input capacitance	$C_{in}$	—	—	5	10	—	10	pF			

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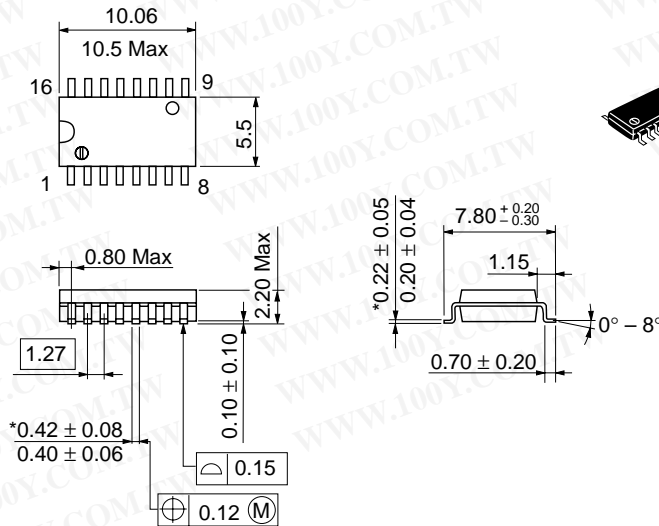
Package Dimensions

Unit: mm



Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Mass (reference value)	1.07 g

Unit: mm

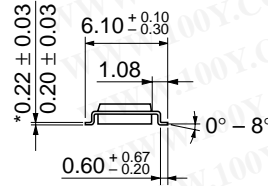
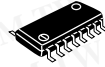
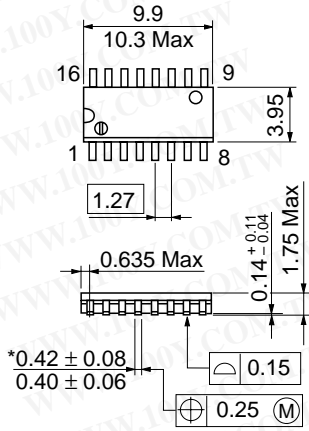


\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.24 g

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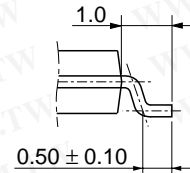
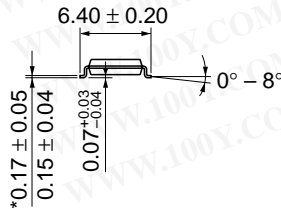
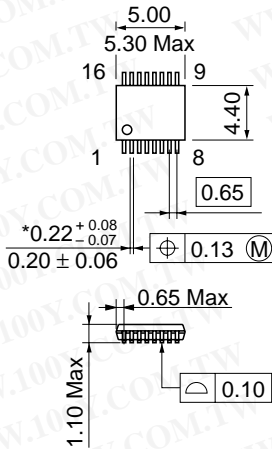
Unit: mm



\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Mass (reference value)	0.15 g

Unit: mm



\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	TTP-16DA
JEDEC	—
EIAJ	—
Mass (reference value)	0.05 g



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